

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOS -H)

# TK80E07NE

■ E-Bike/UPS/Inverter

Note : This product is designed for E-Bike / UPS / Inverter in China / India market.

- Low drain-source on-resistance :  $R_{DS(ON)} = 6.9\text{ m}\Omega$  (typ.)
- Low leakage current :  $I_{DSS} = 10\text{ }\mu\text{A}$  (max) ( $V_{DS} = 70\text{ V}$ )
- Enhancement mode :  $V_{th} = 2.0\sim 4.0\text{ V}$  ( $V_{DS} = 10\text{ V}$ ,  $I_D = 0.3\text{ mA}$ )

**Absolute Maximum Ratings (Ta = 25°C)**

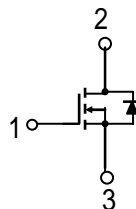
Characteristics	Symbol	Rating	Unit	
Drain-source voltage	$V_{DSS}$	70	V	
Drain-gate voltage ( $R_{GS} = 20\text{ k}\Omega$ )	$V_{DGR}$	70	V	
Gate-source voltage	$V_{GSS}$	$\pm 20$	V	
Drain current	DC (Note 1)	$I_D$	80	A
	DC (Note 1,4)	$I_D$	58	A
	Pulse (Note 1)	$I_{DP}$	240	A
Drain power dissipation ( $T_c = 25^\circ\text{C}$ )	$P_D$	87	W	
Single pulse avalanche energy (Note 2)	$E_{AS}$	16.4	mJ	
Avalanche current	$I_{AR}$	40	A	
Repetitive avalanche energy (Note 3)	$E_{AR}$	8.7	mJ	
Peak diode recovery dv/dt (Note 5)	dv/dt	11.5	V/ns	
Channel temperature (Note 4)	$T_{ch}$	175	$^\circ\text{C}$	
Storage temperature range (Note 4)	$T_{stg}$	$-55\sim 175$	$^\circ\text{C}$	

**Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th(ch-c)}$	1.72	$^\circ\text{C/W}$
Thermal resistance, channel to ambient	$R_{th(ch-a)}$	83.3	$^\circ\text{C/W}$

- Note 1: Ensure that the channel temperature does not exceed 175°C.  
 Note 2:  $V_{DD} = 25\text{ V}$ ,  $T_{ch} = 25^\circ\text{C}$  (initial),  $L = 14.9\text{ }\mu\text{H}$ ,  $R_G = 25\text{ }\Omega$ ,  $I_{AR} = 40\text{ A}$   
 Note 3: Repetitive rating: pulse width limited by maximum channel temperature  
 Note 4:  $T_c = 100^\circ\text{C}$   
 Note 5:  $I_{DR} = 80\text{ A}$ ,  $di/dt = 160\text{ A}/\mu\text{s}$ ,  $T_{ch} = T_{ch\text{ max.}}$ ,  $V_{DS\text{ peak}} < V_{DSS}$

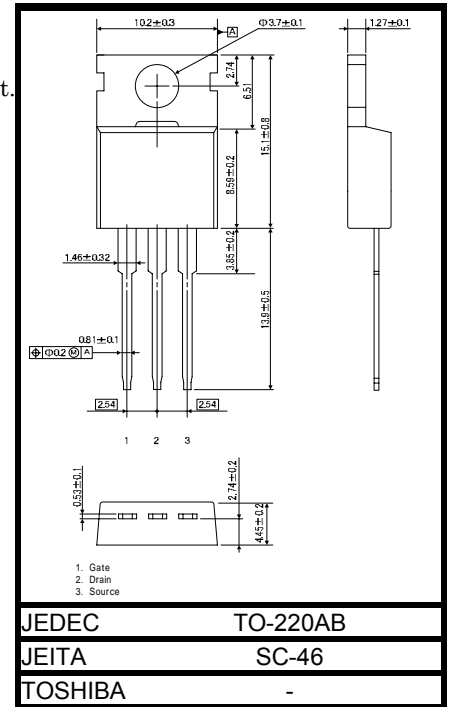
This transistor is an electrostatic-sensitive device. Please handle with caution.



Note :Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

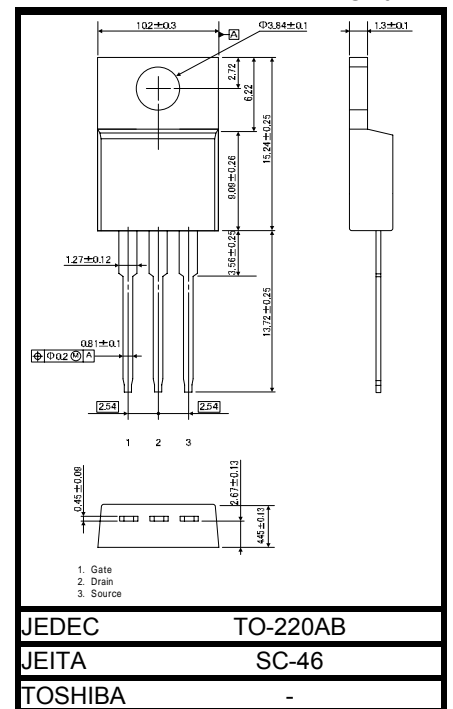
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Unit: mm



Weight: 1.93g (typ)

Unit: mm



Weight: 1.9 g (typ.)

## Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		$I_{GSS}$	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 1$	$\mu\text{A}$
Drain cut-off current		$I_{DSS}$	$V_{DS} = 70\text{ V}, V_{GS} = 0\text{ V}$	—	—	10	$\mu\text{A}$
Drain-source breakdown voltage		$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	70	—	—	V
		$V_{(BR)DSX}$	$I_D = 10\text{ mA}, V_{GS} = -20\text{ V}$ (Note 5)	45	—	—	V
Gate threshold voltage		$V_{th}$	$V_{DS} = 10\text{ V}, I_D = 0.3\text{ mA}$	2.0	—	4.0	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = 10\text{ V}, I_D = 40\text{ A}$	—	6.9	8.5	$\text{m}\Omega$
Input capacitance		$C_{iss}$	$V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	2270	—	pF
Reverse transfer capacitance		$C_{rss}$		—	230	—	
Output capacitance		$C_{oss}$		—	1390	—	
Switching time	Rise time	$t_r$		—	12	—	ns
	Turn-on time	$t_{on}$		—	31	—	
	Fall time	$t_f$		—	17	—	
	Turn-off time	$t_{off}$		Duty $\leq 1\%$ , $t_w = 10\ \mu\text{s}$	—	47	
Total gate charge (Gate-source plus gate-drain)		$Q_g$	$V_{DD} \approx 56\text{ V}, V_{GS} = 10\text{ V}, I_D = 80\text{ A}$	—	42	—	nC
Gate-source charge		$Q_{gs}$		—	28	—	
Gate-drain ("miller") charge		$Q_{gd}$		—	14	—	

## Source-Drain Ratings and Characteristics (Ta = 25°C)

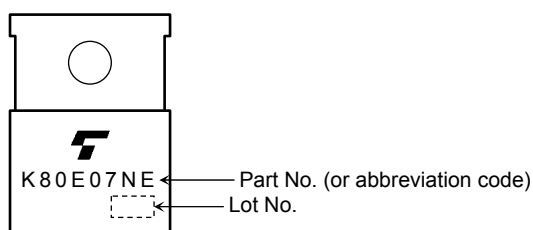
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	$I_{DR}$	—	—	—	80	A
Pulse drain reverse current (Note 1)	$I_{DRP}$	—	—	—	240	A
Forward voltage (diode)	$V_{DSF}$	$I_{DR} = 80\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.5	V
Reverse recovery time (Note 6)	$t_{rr}$	$I_{DR} = 80\text{ A}, V_{GS} = 0\text{ V}$	—	60	—	ns
Reverse recovery charge (Note 6)	$Q_{rr}$	$dI_{DR}/dt = 50\text{ A}/\mu\text{s}$	—	45	—	nC

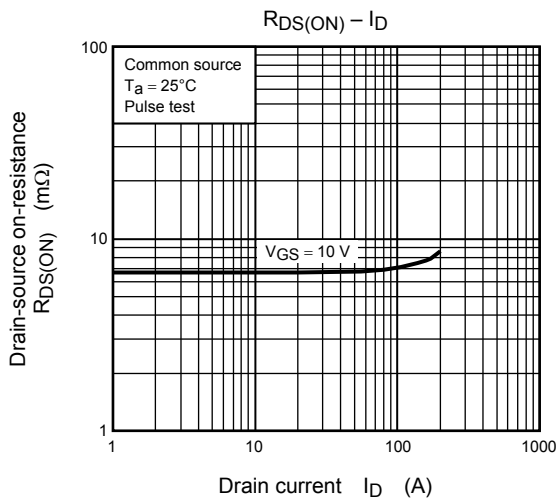
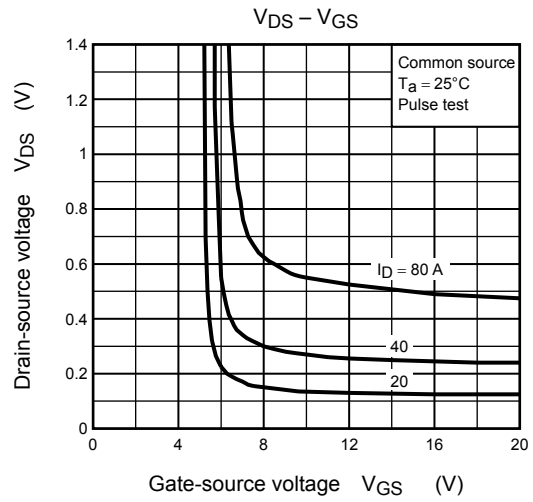
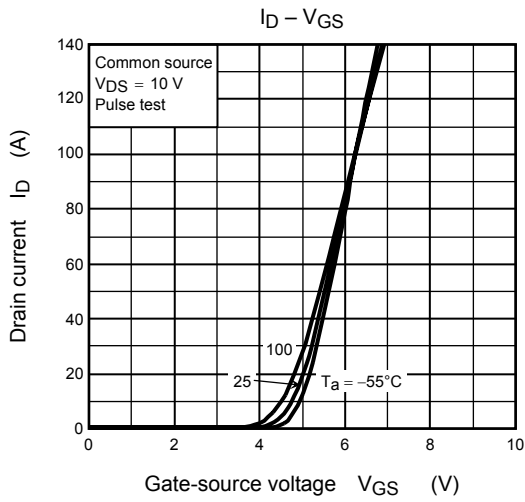
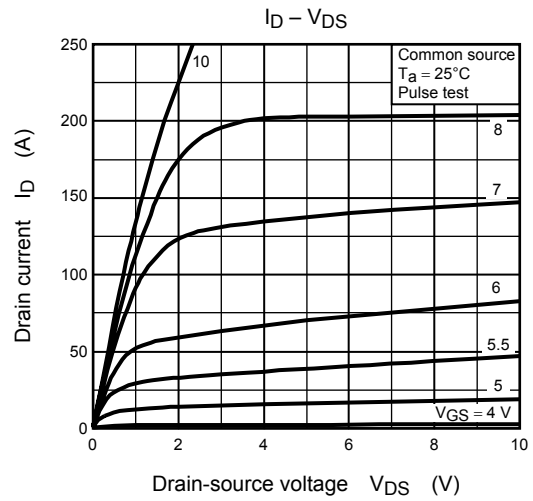
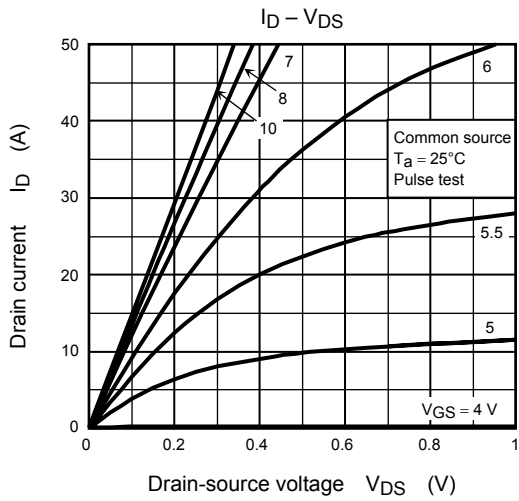
Note 5: If a reverse bias is applied between gate and source, this device enters  $V_{(BR)DSX}$  mode.

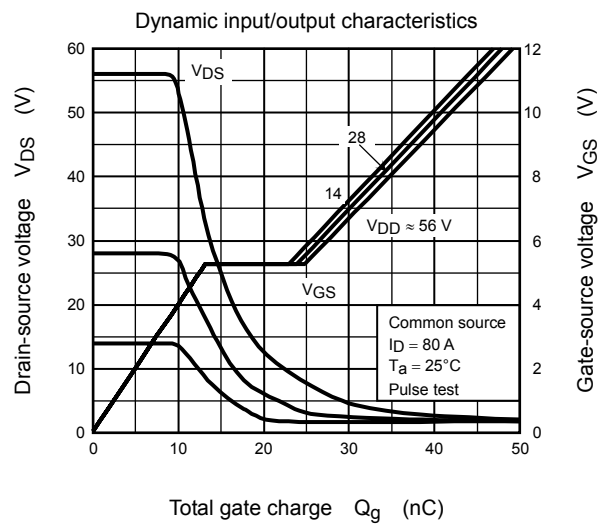
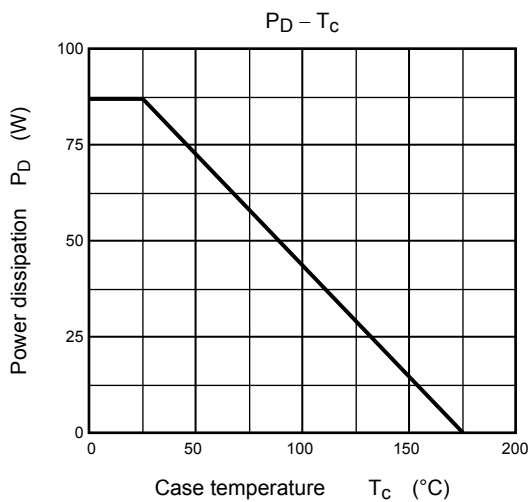
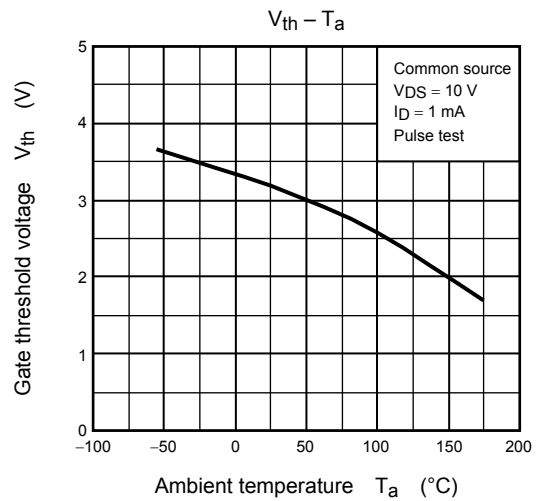
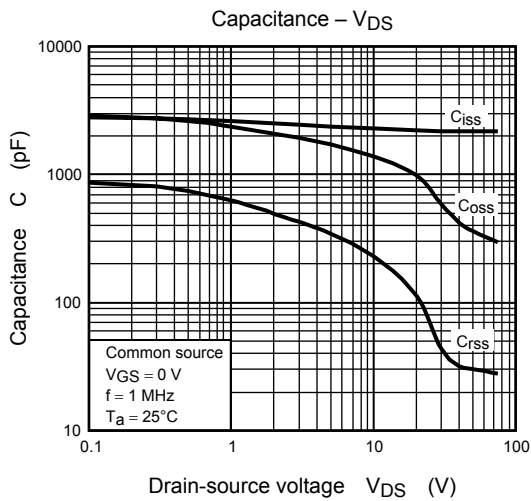
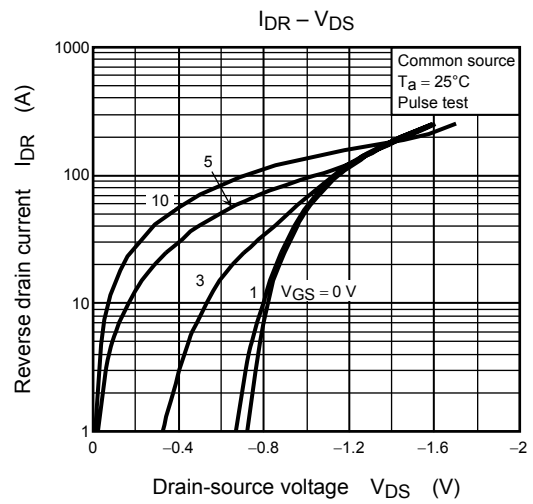
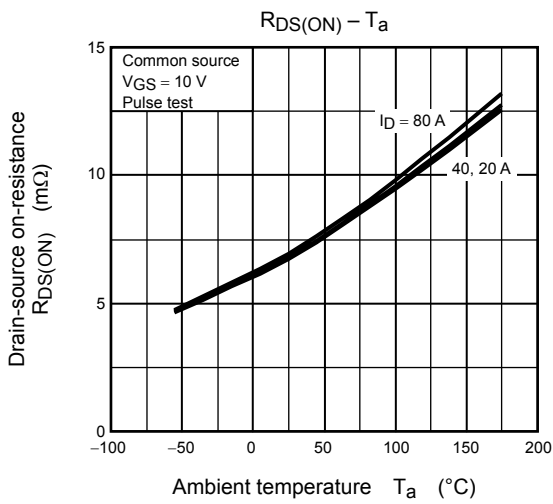
Note that the drain-source breakdown voltage is lowered in this mode.

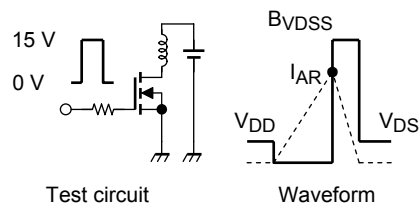
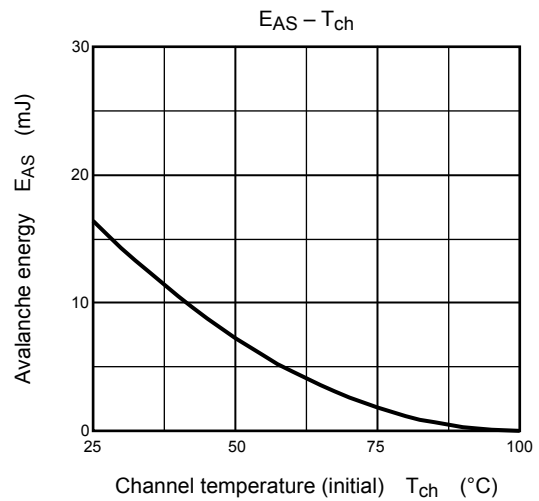
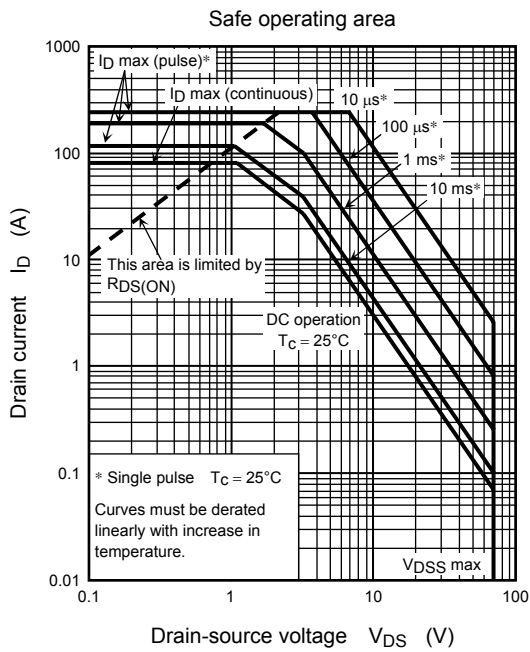
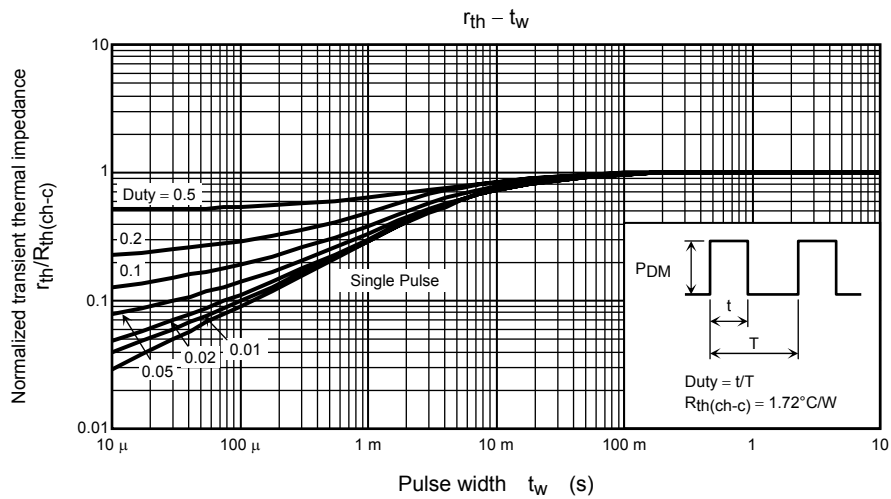
Note 6: Ensure that  $V_{DS}$  peak does not exceed  $V_{DSS}$ .

## Marking









$R_G = 25 \Omega$   
 $V_{DD} = 25 \text{ V}, L = 14.9 \mu\text{H}$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I_{AR}^2 \cdot \left( \frac{BVDSS}{BVDSS - V_{DD}} \right)$$

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